



Material declaration form

General Information			
IPC	1752	Version	2
Form type*	Distribute		
Sectionals*	Material information	Subsectionals*	A-D
	Manufacturing information		

*: Required Field

Supplier Information			
Company name*	STMicroelectronics	Response Date*	2025-08-04
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact phone*	Refer to Supplier Comment section	Contact email*	Refer to Supplier Comment section
Authorized representative*	Floriana SAN BIAGIO	Representative title	APMS Material Declaration champion
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section
Supplier comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty statement

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Legal statement

Supplier acceptance*	true	Legal declaration*	Standard
Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.			

Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
	3D6P*US5O1CA	A	64BA-BO2A	2025-08-04
	Amount	Unit of measure	Unit type	ST ECOPACK grade
	35	mg	Each	ECOPACK® 3
Identity	Authority			
Comment	ECOPACK® 3 is STMicroelectronics trade name for ROHS compliant device without use of any ROHS exemption and without Halogen nor Antimony			

Manufacturing information				
J-STD-020 MSL rating	Classification temperature	Number of reflow cycles		
1	260	3		
Bulk solder termination	Terminal plating	Terminal base alloy	Comment	
Not Applicable	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy	0	
Package designator	Package size	Number of instances	Shape	
DSO	4.4x3	8	gull wing	
Comment				
Comment	6P TSSOP 8 BODY 4.4 PITCH 0.65; MDF is valid for TSC2020IPT			

QueryList : RoHS Directive 2011/65/EU - 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015		Response
1 - Product(s) meets EU RoHS requirement without any exemptions		true
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)		false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions		false
Exemption Id.	Description	

QueryList : ELV directive : 2000/53/EC amended 2020/363_March 2020		Response
1 - Product(s) meets EU ELV requirements without any exemptions		true
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
Exemption Id.	Description	

QueryList : California Prop65 list, dated 3rd January 2025				Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen				false
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen				true
Substance	amount in product (mg)	Application	ppm in product	
Nickel	0.137	alloy	3927	
Lead	0.000		0	
Lead-Borate Glass	0.000		0	
Lead Zirconate Titanate	0.000		0	
Antimony trioxide	0.000		0	
Bisphenol A	0.000		0	

QueryList :Customer		Response
QUERY		Response

QueryList : Chinese RoHS , references : SJT 11364 – 2014 and GBT 26572 – 2014					Response
QUERY					Response
1 - Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products					false
2 - Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products					false
Hazardous substance					
Lead (Pb)	Cadmium (Cd)	Mercury (Hg)	Hexavalent Chromium (Cr VI)	PBB & PBDE	
0	0	0	0	0	

QueryList : REACH-25th June 2025					Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH					true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product	
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH					true
CategoryLevel_Name	CategoryLevel_Threshold	Amount in embedded article / Homogeneous material (mg)	Application - article / Homogeneous material	ppm in article /Homogeneous material	



QueryList : Responsible metals sourcing	Response
The component is containing at least one of the following metals : Cobalt , Gold , Tantalum , Tin , Tungsten.	true
The following metals are present is the component :	Gold,

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update	Response
The Product does contain at least one of the substances listed in Chemical Control Act	false

QueryList : China GB 33372-2020 Limit standard for volatile organic compounds content in adhesives - 4 March 2020 application date 1st December 2020	Response
The product contains adhesives identified under GB 33372	true
All the adhesive impacted complies with GB 33372	true

QueryList:Stockholm Convention Persistent Organic Pollutants (POP)	Response
Product is compliant with Annex A, B and C of Stockholm Convention Persistent Organic Pollutants	true

QueryList: EU Ship Recycling Regulation No. 1257/2013	Response
Product contains hazardous materials listed in Annex II of EU Ship Recycling Regulation No.1257/2013 and 2009/16/EC Directive	False

PFAS/PTFE Declaration	Response
QUERY	Response
The product is containing fluorinated substance.	False
Substance Name, CAS	
Polytetrafluoroethylene, CAS 9002-84-0	False
Thiophenium CAS, 209482-18-8	False
Triphenylsulfonium nonaflate, CAS 144317-44-2	False
Trifluoroacetic anhydrid,e CAS 407-25-0	False

BPA Declaration	Response
Product does not contain Bisphenol A (Isopropylidenediphenol)	True

Montreal Protocol	Response
Product does not contain Ozone Depleting Substances based on Annex I to Annex VII of EU REGULATION (EC) No 1005/2009	True

Environmental Protection Agency:Toxic Substances Control Act (TSCA). Section 6(h)	Response
Product does not contain Phenol, isopropylated, phosphate (3:1)	True



Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document							Mfr Item Name	3D6P*US5O1CA		34.8900		4999999.0	1000002.0
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)	
Die or Dies or Wafer (choose)	M-011 Other inorganic materials	2.032	mg	supplier	die	Silicon(Si)	7440-21-3		1.915	mg	942421	54887	
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.019	mg	9350	545	
				supplier	metallisation	Copper(Cu)	7440-50-8		0.003	mg	1476	86	
				supplier	metallisation	Titanium(Ti)	7440-32-6		0.001	mg	492	29	
				supplier	Passivation	Silicon nitride(Si)	12033-89-5		0.005	mg	2461	143	
				supplier	passivation	Silicon oxide	7631-86-9		0.047	mg	23130	1347	
				supplier	polymer coating	polyimide	proprietary		0.042	mg	20669	1204	
Leadframe	M-004 Copper and its alloys	10.552	mg	supplier	alloy	Copper(Cu)	7440-50-8		10.139	mg	960861	290599	
				supplier	alloy	Iron(Fe)	7439-89-6		0.239	mg	22650	6850	
				supplier	alloy	Iron phosphide	1310-43-6		0.014	mg	1327	401	
				supplier	alloy	Zinc(Zn)	7440-66-6		0.013	mg	1232	373	
				supplier	metallization	Nickel(Ni)	7440-02-0		0.137	mg	12983	3927	
				supplier	metallization	Palladium(Pd)	7440-05-3		0.004	mg	379	115	
				supplier	metallization	Gold(Au)	7440-57-5		0.006	mg	569	172	
Die attach	M-015 Other organic materials	0.280	mg	supplier	glue	Silver(Ag)	7440-22-4		0.246	mg	878571	7051	
				supplier	glue	Isobornyl Metha	7534-94-3		0.014	mg	50000	401	
				supplier	glue	Isobornyl acryla	5888-33-5		0.014	mg	50000	401	
				supplier	glue	Methyl acrylate	87320-05-6		0.006	mg	21429	172	
Bonding wires	M-008 Precious metals	0.104	mg	supplier	wire	Gold(Au)	7440-57-5		0.104	mg	1000000	2981	
Encapsulation	M-015 Other organic materials	21.922	mg	supplier	mold compound	Silica vitreous	60676-86-0		15.696	mg	715993	449871	
				supplier	mold compound	Silicon oxide	7631-86-9		3.288	mg	149986	94239	
				supplier	mold compound	Biphenyl epoxy	85954-11-6		1.644	mg	74993	47120	
				supplier	mold compound	Phenol resin	26834-02-6		1.096	mg	49995	31413	
				supplier	mold compound	Carbon black	1333-86-4		0.110	mg	5018	3153	
				supplier	mold compound	Bismuth compo	7440-69-9		0.088	mg	4014	2522	